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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

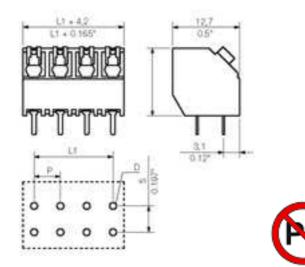


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General ordering data

Order No. Part designation Version

EAN Qty.

System parameters

Product family Conductor connection system Fitted to PCB Outgoing direction of conductor Pitch Pitch in inch No. of poles Fitted by customer No. of rows Solder pin length Dia. of fitting hole Fitting hole tolerance No. of solder pins per pole Stripping length 1884820000 LSF-SMT5.08/11/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 11, 135°, Tube 4032248489398 10 pc(s).

System LS
Push In
Reflow solder connection
135°
5.08 mm
0.2 inch
11
yes
1
1.5 mm
1.1 mm
+ 0.1 mm
2
8 mm



System parameters	F0.0
L1 in mm	50.8 mm
L1 in inch	2 inch
Electric shock protection to DIN VDE 0470	IP 20
Electric shock protection to DIN VDE 0470	Safe from finger touch
Material data	
Insulating material	LCP GF
Colour	black
colour chart	Similar to RAL 9011
Insulating material group	Illa
Flammability class UL 94	V-0
CTI	>= 175
Contact base material	Copper alloy
Contact surface	tinned
Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C
Connectable conductors	
Clamping range, min.	0.13 mm ²
Clamping range, max.	1.5 mm ²
AWG, min.	24
AWG, max.	16
O.D. of conductor insulation, max.	2.9 mm
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm ²
Flexible, min. H05(07) V-K	0.2 mm ²
Flexible, max. H05(07) V-K	1.5 mm ²
With wire end ferrule, acc. to DIN 46 228/1, min.	0.25 mm ²
With wire end ferrule, acc. to DIN 46 228/1, max.	1.5 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.25 mm²
w. plastic collar ferrule, DIN 46228 pt 4, max.	0.75 mm²
DIN IEC rating data	
Rated current, min. No. pins (Tu=20°C)	17.5 A
Rated current, max. No. pins (Tu=20°C)	17.5 A
Rated current, min. No. pins(Tu=40°C)	17.5 A
Rated current, max. No. pins (Tu=40°C)	15 A
Rated voltage for overvoltage class/pollution	500 V
severity II/2	
Rated voltage for overvoltage class/pollution	320 V
severity III/2	
Rated voltage for overvoltage class/pollution	250 V
severity III/3	
Rated impulse withstand voltage for overvoltage	4 kV
class/pollution severity II/2	
Rated impulse withstand voltage for overvoltage	4 kV
class/pollution severity III/2	
Rated impulse withstand voltage for overvoltage	4 kV
class/pollution severity III/3	
Short-time withstand current resistance	3 x 1s with 80 A



Rated voltage (Use group D)	300 V
Rated current (Use group D)	10 A
AWG conductor (field wiring), min.	24
AWG conductor (field wiring), max.	16
UL 1059 rating data	
Rated voltage (Use group D)	300 V
Rated current (Use group D)	10 A
AWG conductor, min.	24
AWG conductor, max.	16
	10

Approvals

Approvals institutes



Classifications

eClass 5.1

27-26-11-01

Similar products

Order No. 1885020000	Part designation LSF-SMT5.08/2/135 3.5
1888780000	LSF-SMT5.08/2/135 3.5R
1884730000	LSF-SMT5.08/2/135 1.5
1888710000	LSF-SMT5.08/2/135 1.5R
1885030000	LSF-SMT5.08/3/135 3.5
1888790000	LSF-SMT5.08/3/135 3.5R
1884740000	LSF-SMT5.08/3/135 1.5
1888720000	LSF-SMT5.08/3/135 1.5R
1885040000	LSF-SMT5.08/4/135 3.5
1888810000	LSF-SMT5.08/4/135 3.5R
1884750000	LSF-SMT5.08/4/135 1.5
1888730000	LSF-SMT5.08/4/135 1.5R

PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 2, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 2, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 2, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 2, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 3, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 3, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 3, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 3, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 4, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 4, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 4, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 4, 135°, Tape



1885050000	LSF-SMT5.08/5/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 5, 135°, Tube
1888830000	LSF-SMT5.08/5/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 5, 135°, Tape
1884760000	LSF-SMT5.08/5/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 5, 135°, Tube
1888740000	LSF-SMT5.08/5/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885060000	LSF-SMT5.08/6/135 3.5	max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 5, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range,
1888840000	LSF-SMT5.08/6/135 3.5R	max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 6, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
1884770000	LSF-SMT5.08/6/135 1.5	max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 6, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range,
1888750000	LSF-SMT5.08/6/135 1.5R	max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 6, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
1005070000		max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 6, 135°, Tape
1885070000	LSF-SMT5.08/7/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 7, 135°, Tube
1888870000	LSF-SMT5.08/7/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
4004700000		max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 7, 135°, Tape
1884780000	LSF-SMT5.08/7/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 7, 135°, Tube
1888760000	LSF-SMT5.08/7/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 7, 135°, Tape
1885080000	LSF-SMT5.08/8/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 8, 135°, Tube
1888880000	LSF-SMT5.08/8/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 8, 135°, Tape
1884790000	LSF-SMT5.08/8/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 8, 135°, Tube
1888770000	LSF-SMT5.08/8/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 8, 135°, Tape
1885090000	LSF-SMT5.08/9/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 9, 135°, Tube
1884800000	LSF-SMT5.08/9/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885100000	LSF-SMT5.08/10/135 3.5	max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 9, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 10, 135°, Tube
1884810000	LSF-SMT5.08/10/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 10, 135°, Tube
1885110000	LSF-SMT5.08/11/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 11, 135°, Tube
1885120000	LSF-SMT5.08/12/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 12, 135°, Tube
1884830000	LSF-SMT5.08/12/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 12, 135°, Tube
1885130000	LSF-SMT5.08/13/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 13, 135°, Tube
1884840000	LSF-SMT5.08/13/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 13, 135°, Tube
1885150000	LSF-SMT5.08/15/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 15, 135°, Tube



1884860000	LSF-SMT5.08/15/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 5.08 mm, No. of poles: 15, 135°, Tube
1885140000	LSF-SMT5.08/14/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 14, 135°, Tube
1884850000	LSF-SMT5.08/14/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 14, 135°, Tube
1885160000	LSF-SMT5.08/16/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 16, 135°, Tube
1884870000	LSF-SMT5.08/16/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 16, 135°, Tube



